

BUL44

SWITCHMODE™

NPN Bipolar Power Transistor For Switching Power Supply Applications

The BUL44 have an applications specific state-of-the-art die designed for use in 220 V line operated Switchmode Power supplies and electronic light ballasts.

Features

- Improved Efficiency Due to Low Base Drive Requirements:
 - High and Flat DC Current Gain h_{FE}
 - Fast Switching
 - No Coil Required in Base Circuit for Turn-Off (No Current Tail)
- Full Characterization at 125°C
- Tight Parametric Distributions are Consistent Lot-to-Lot
- Pb-Free Package is Available*

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-Emitter Sustaining Voltage	V_{CEO}	400	Vdc
Collector-Base Breakdown Voltage	V_{CES}	700	Vdc
Emitter-Base Voltage	V_{EBO}	9.0	Vdc
Collector Current <ul style="list-style-type: none">- Continuous- Peak (Note 1)	I_C I_{CM}	2.0 5.0	Adc
Base Current <ul style="list-style-type: none">- Continuous- Peak (Note 1)	I_B I_{BM}	1.0 2.0	Adc
Total Device Dissipation @ $T_C = 25^\circ\text{C}$ Derate above 25°C	P_D	50 0.4	W W/°C
Operating and Storage Temperature	T_J, T_{stg}	-65 to 150	°C

THERMAL CHARACTERISTICS

Characteristics	Symbol	Max	Unit
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	2.5	°C/W
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	62.5	°C/W
Maximum Lead Temperature for Soldering Purposes 1/8" from Case for 5 Seconds	T_L	260	°C

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

1. Pulse Test: Pulse Width = 5 ms, Duty Cycle \leq 10%.

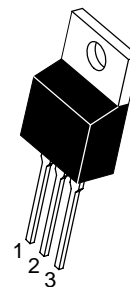
*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.



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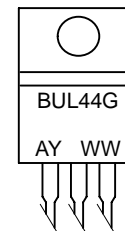
<http://onsemi.com>

POWER TRANSISTOR 2.0 AMPERES, 700 VOLTS, 40 AND 100 WATTS



TO-220AB
CASE 221A-09
STYLE 1

MARKING DIAGRAM



BUL44 = Device Code
A = Assembly Location
Y = Year
WW = Work Week
G = Pb-Free Package

ORDERING INFORMATION

Device	Package	Shipping
BUL44	TO-220	50 Units / Rail
BUL44G	TO-220 (Pb-Free)	50 Units / Rail

BUL44

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Typ	Max	Unit		
OFF CHARACTERISTICS							
Collector–Emitter Sustaining Voltage (I _C = 100 mA, L = 25 mH)	V _{CEO(sus)}	400	–	–	Vdc		
Collector Cutoff Current (V _{CE} = Rated V _{CEO} , I _B = 0)	I _{CEO}	–	–	100	μAdc		
Collector Cutoff Current (V _{CE} = Rated V _{CEs} , V _{EB} = 0) (V _{CE} = 500 V, V _{EB} = 0)	I _{CEs}	– – –	– – –	100 500 100	μAdc		
(T _C = 125°C) (T _C = 125°C)							
Emitter Cutoff Current (V _{EB} = 9.0 Vdc, I _C = 0)	I _{EBO}	–	–	100	μAdc		
ON CHARACTERISTICS							
Base–Emitter Saturation Voltage (I _C = 0.4 Adc, I _B = 40 mAdc) (I _C = 1.0 Adc, I _B = 0.2 Adc)	V _{BE(sat)}	– –	0.85 0.92	1.1 1.25	Vdc		
Collector–Emitter Saturation Voltage (I _C = 0.4 Adc, I _B = 40 mAdc) (I _C = 1.0 Adc, I _B = 0.2 Adc)	V _{CE(sat)}	– – – –	0.20 0.20 0.25 0.25	0.5 0.5 0.6 0.6	Vdc		
(T _C = 125°C) (T _C = 125°C)							
DC Current Gain (I _C = 0.2 Adc, V _{CE} = 5.0 Vdc) (I _C = 0.4 Adc, V _{CE} = 1.0 Vdc) (I _C = 1.0 Adc, V _{CE} = 1.0 Vdc) (I _C = 10 mAdc, V _{CE} = 5.0 Vdc)	h _{FE}	14 – 12 12 8.0 7.0 10	– 32 20 20 14 13 22	34 – – – – – –	–		
(T _C = 125°C) (T _C = 125°C) (T _C = 125°C)							
DYNAMIC CHARACTERISTICS							
Current Gain Bandwidth (I _C = 0.5 Adc, V _{CE} = 10 Vdc, f = 1.0 MHz)	f _T	–	13	–	MHz		
Output Capacitance (V _{CB} = 10 Vdc, I _E = 0, f = 1.0 MHz)	C _{OB}	–	38	60	pF		
Input Capacitance (V _{EB} = 8.0 V)	C _{IB}	–	380	600	pF		
Dynamic Saturation Voltage: Determined 1.0 μs and 3.0 μs respectively after rising I _{B1} reaches 90% of final I _{B1}	(I _C = 0.4 Adc I _{B1} = 40 mAdc V _{CC} = 300 V)	1.0 μs	(T _C = 125°C)	– –	2.5 2.7	– –	Vdc
		3.0 μs	(T _C = 125°C)	– –	1.3 1.15	– –	
	(I _C = 1.0 Adc I _{B1} = 0.2 Adc V _{CC} = 300 V)	1.0 μs	(T _C = 125°C)	– –	3.2 7.5	– –	
		3.0 μs	(T _C = 125°C)	– –	1.25 1.6	– –	

BUL44

SWITCHING CHARACTERISTICS: Resistive Load (D.C. ≤ 10%, Pulse Width = 20 μs)

Turn-On Time	($I_C = 0.4 \text{ Adc}$, $I_{B1} = 40 \text{ mAdc}$ $I_{B2} = 0.2 \text{ Adc}$, $V_{CC} = 300 \text{ V}$)	($T_C = 125^\circ\text{C}$)	t_{on}	– –	40 40	100 –	ns
Turn-Off Time	($I_C = 0.4 \text{ Adc}$, $I_{B1} = 40 \text{ mAdc}$ $I_{B2} = 0.2 \text{ Adc}$, $V_{CC} = 300 \text{ V}$)	($T_C = 125^\circ\text{C}$)	t_{off}	– –	1.5 2.0	2.5 –	μs
Turn-On Time	($I_C = 1.0 \text{ Adc}$, $I_{B1} = 0.2 \text{ Adc}$ $I_{B2} = 0.5 \text{ Adc}$, $V_{CC} = 300 \text{ V}$)	($T_C = 125^\circ\text{C}$)	t_{on}	– –	85 85	150 –	ns
Turn-Off Time	($I_C = 1.0 \text{ Adc}$, $I_{B1} = 0.2 \text{ Adc}$ $I_{B2} = 0.5 \text{ Adc}$, $V_{CC} = 300 \text{ V}$)	($T_C = 125^\circ\text{C}$)	t_{off}	– –	1.75 2.10	2.5 –	μs

SWITCHING CHARACTERISTICS: Inductive Load ($V_{clamp} = 300 \text{ V}$, $V_{CC} = 15 \text{ V}$, $L = 200 \mu\text{H}$)

Fall Time	($I_C = 0.4 \text{ Adc}$, $I_{B1} = 40 \text{ mAdc}$ $I_{B2} = 0.2 \text{ Adc}$)	($T_C = 125^\circ\text{C}$)	t_{fi}	– –	125 120	200 –	ns
Storage Time		($T_C = 125^\circ\text{C}$)	t_{si}	– –	0.7 0.8	1.25 –	μs
Crossover Time		($T_C = 125^\circ\text{C}$)	t_c	– –	110 110	200 –	ns
Fall Time	($I_C = 1.0 \text{ Adc}$, $I_{B1} = 0.2 \text{ Adc}$ $I_{B2} = 0.5 \text{ Adc}$)	($T_C = 125^\circ\text{C}$)	t_{fi}	– –	110 120	175 –	ns
Storage Time		($T_C = 125^\circ\text{C}$)	t_{si}	– –	1.7 2.25	2.75 –	μs
Crossover Time		($T_C = 125^\circ\text{C}$)	t_c	– –	180 210	300 –	ns
Fall Time	($I_C = 0.8 \text{ Adc}$, $I_{B1} = 160 \text{ mAdc}$ $I_{B2} = 160 \text{ mAdc}$)	($T_C = 125^\circ\text{C}$)	t_{fi}	70 –	– 180	170 –	ns
Storage Time		($T_C = 125^\circ\text{C}$)	t_{si}	2.6 –	– 4.2	3.8 –	μs
Crossover Time		($T_C = 125^\circ\text{C}$)	t_c	– –	190 350	300 –	ns

TYPICAL STATIC CHARACTERISTICS

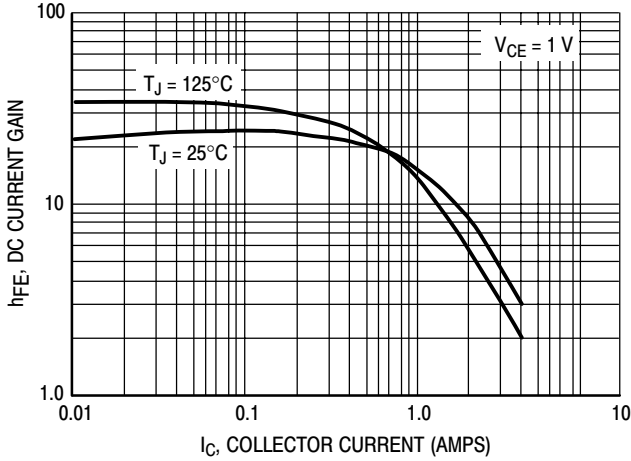


Figure 1. DC Current Gain at 1 Volt

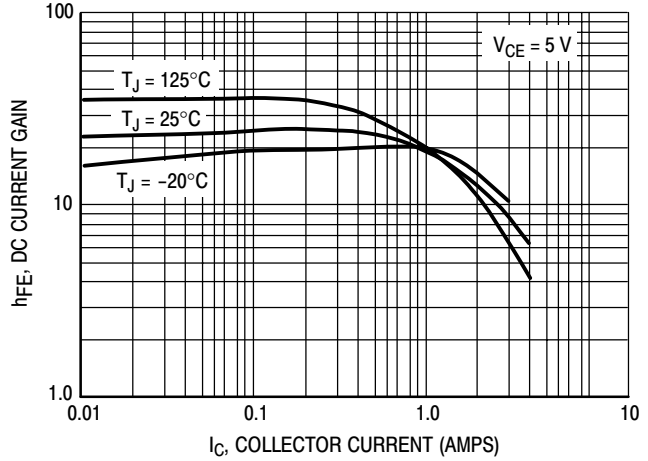


Figure 2. DC Current Gain at 5 Volts

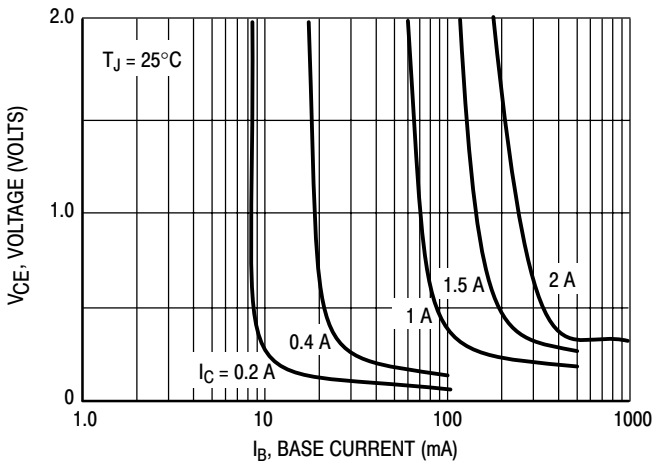


Figure 3. Collector Saturation Region

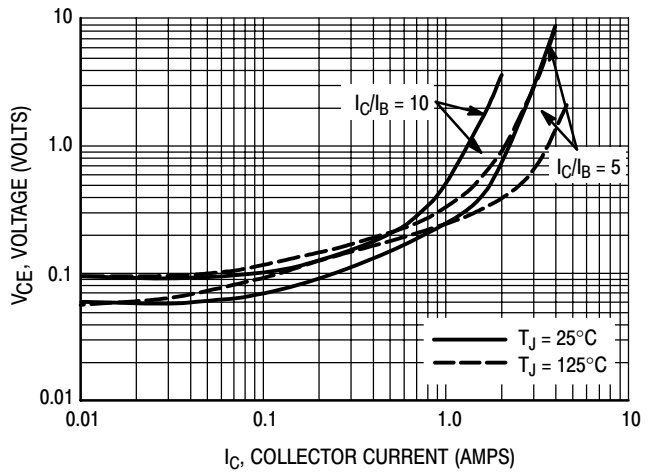


Figure 4. Collector-Emitter Saturation Voltage

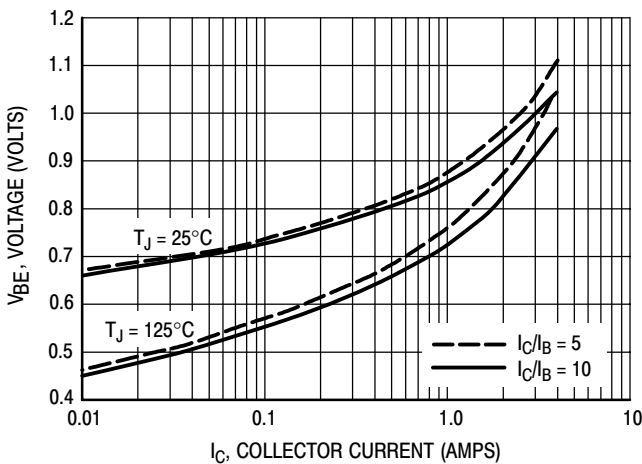


Figure 5. Base-Emitter Saturation Region

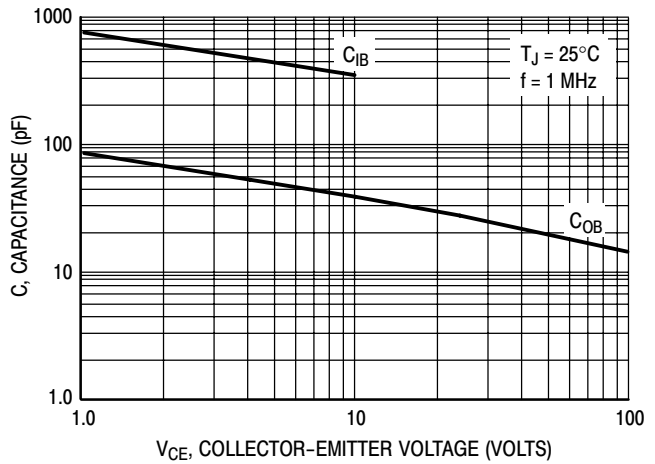


Figure 6. Capacitance

TYPICAL SWITCHING CHARACTERISTICS
($I_{B2} = I_C/2$ for all switching)

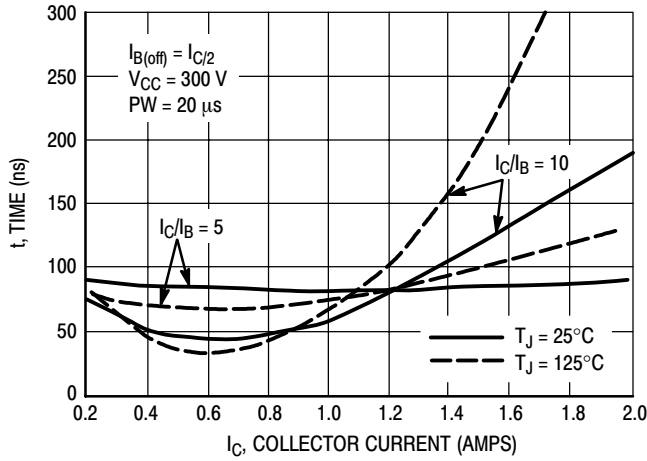


Figure 7. Resistive Switching, t_{on}

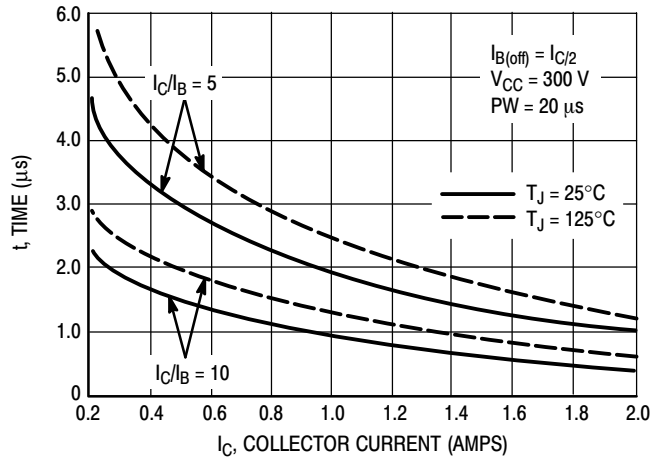


Figure 8. Resistive Switching, t_{off}

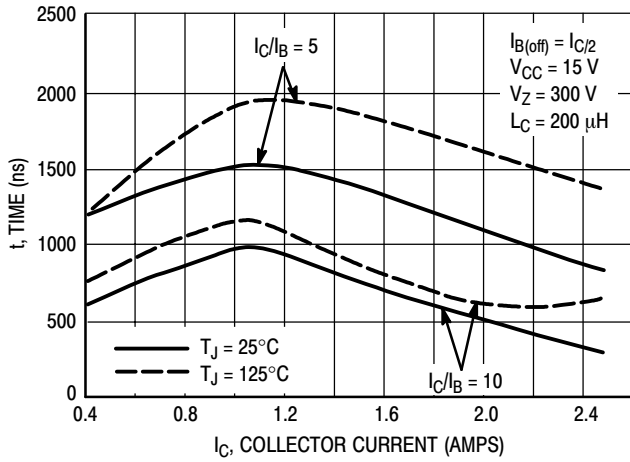


Figure 9. Inductive Storage Time, t_{si}

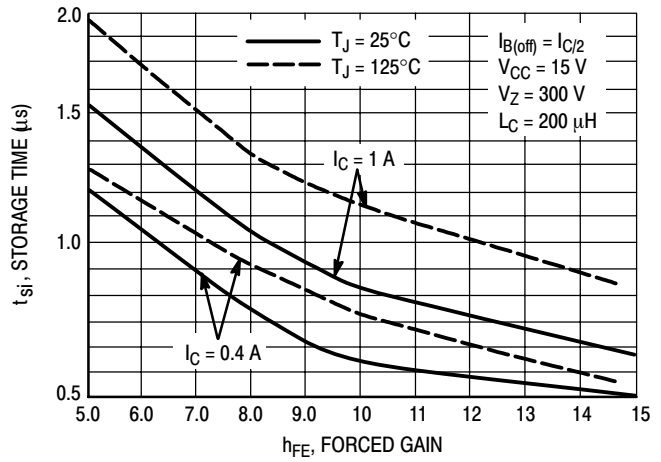


Figure 10. Inductive Storage Time

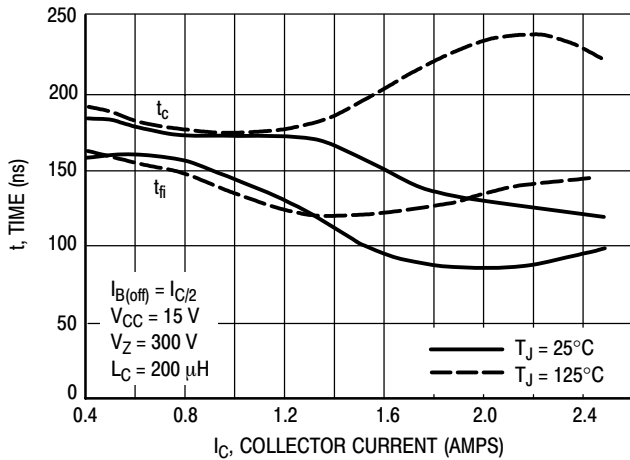


Figure 11. Inductive Switching, t_c and t_{fi} $I_C/I_B = 5$

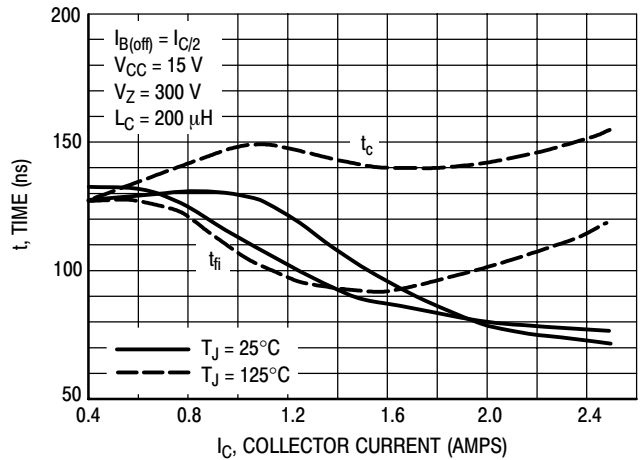


Figure 12. Inductive Switching, t_c and t_{fi} $I_C/I_B = 10$

TYPICAL SWITCHING CHARACTERISTICS
($I_{B2} = I_C/2$ for all switching)

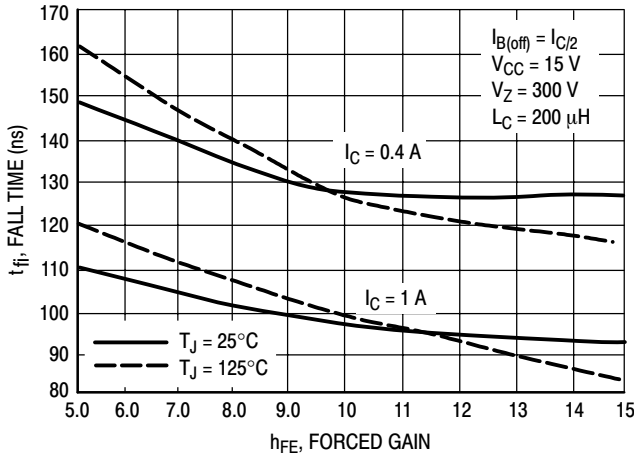


Figure 13. Inductive Fall Time

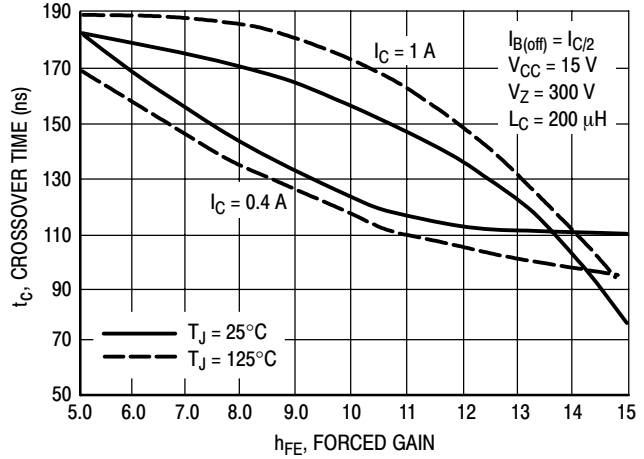


Figure 14. Inductive Crossover Time

GUARANTEED SAFE OPERATING AREA INFORMATION

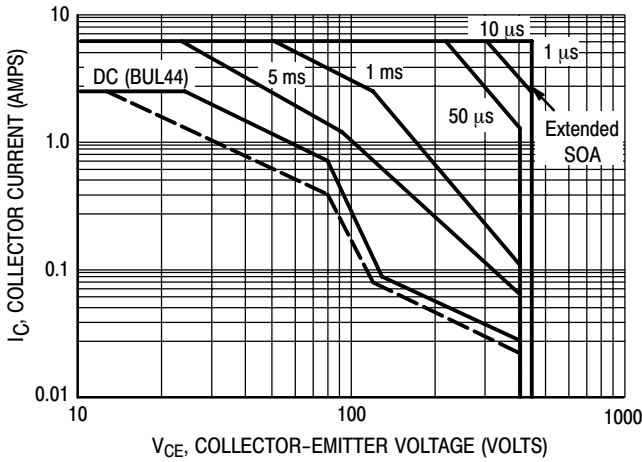


Figure 15. Forward Bias Safe Operating Area

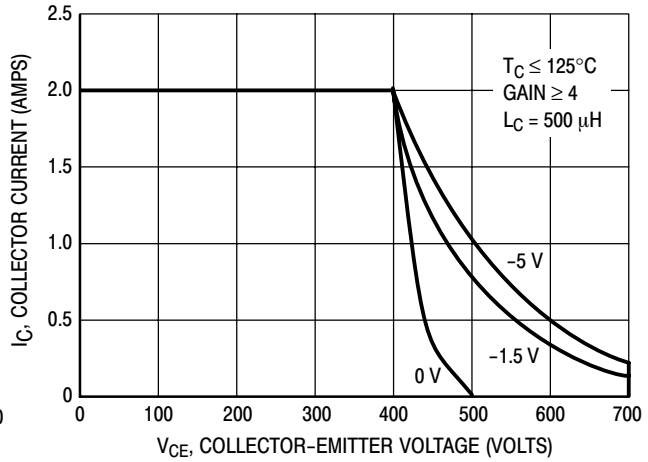


Figure 16. Reverse Bias Switching Safe Operating Area

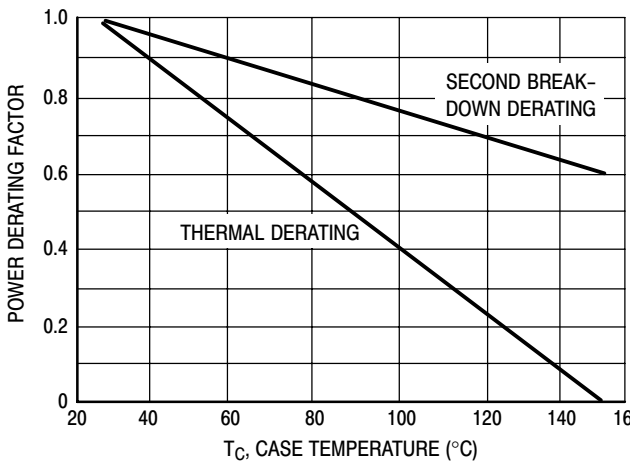


Figure 17. Forward Bias Power Derating

There are two limitations on the power handling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate I_C - V_{CE}

limits of the transistor that must be observed for reliable operation; i.e., the transistor must not be subjected to greater dissipation than the curves indicate. The data of figure 15 is based on $T_C = 25^\circ\text{C}$; $T_{J(PK)}$ is variable depending on power level. Second breakdown pulse limits are valid for duty cycles to 10% but must be derated when $T_C > 25^\circ\text{C}$. Second breakdown limitations do not derate the same as thermal limitations. Allowable current at the voltages shown on figure 15 may be found at any case temperature by using the appropriate curve on figure 17. $T_{J(PK)}$ may be calculated from the data in figure 20. At any case temperatures, thermal limitations will reduce the power than can be handled to values less than the limitations imposed by second breakdown. For inductive loads, high voltage and current must be sustained simultaneously during turn-off with the base-to-emitter junction reverse-biased. The safe level is specified as a reverse-biased safe operating area (Figure 16). This rating is verified under clamped conditions so that the device is never subjected to an avalanche mode.

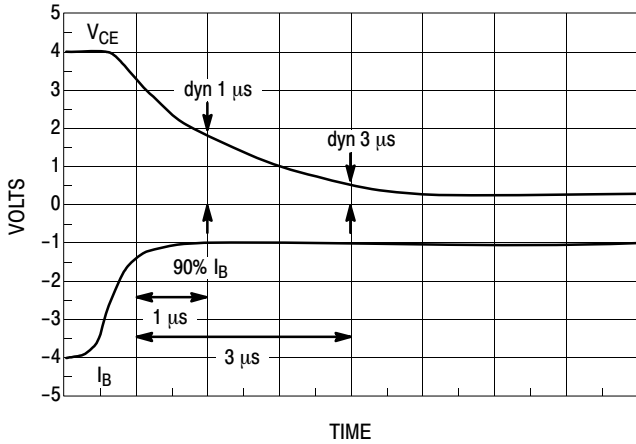


Figure 18. Dynamic Saturation Voltage Measurements

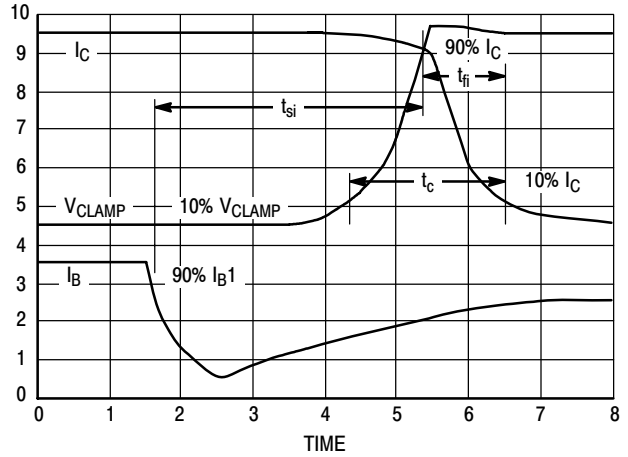


Figure 19. Inductive Switching Measurements

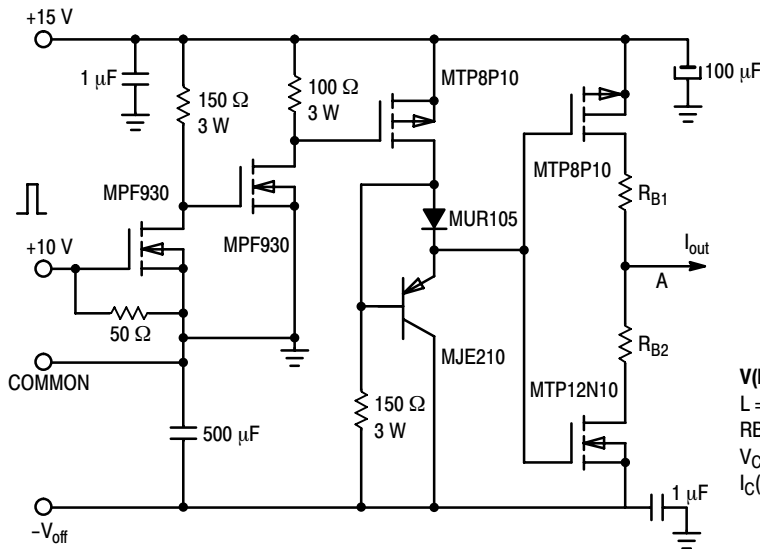
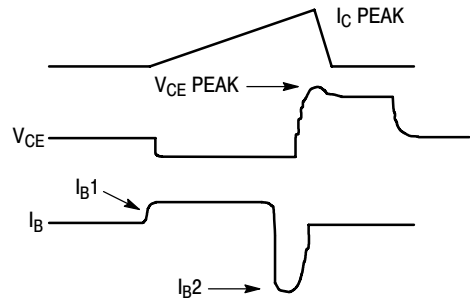


Table 1. Inductive Load Switching Drive Circuit



V(BR)CEO(sus)	INDUCTIVE SWITCHING	RBSOA
L = 10 mH	L = 200 μH	L = 500 μH
RB2 = ∞	RB2 = 0	RB2 = 0
VCC = 20 VOLTS	VCC = 15 VOLTS	VCC = 15 VOLTS
IC(pk) = 100 mA	RB1 SELECTED FOR DESIRED IB1	RB1 SELECTED FOR DESIRED IB1

TYPICAL THERMAL RESPONSE

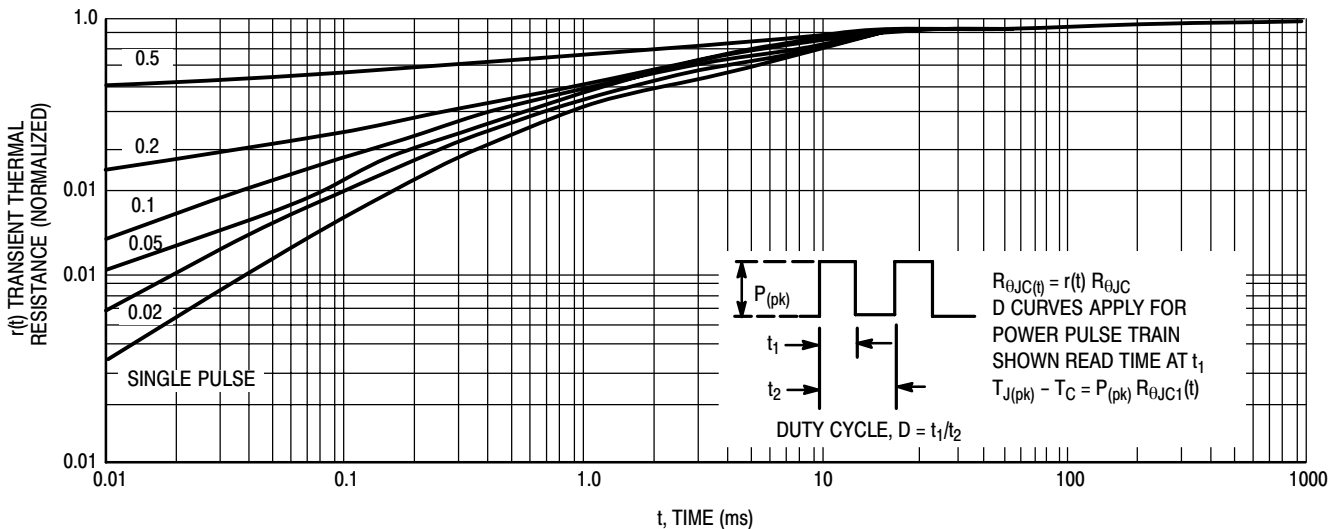
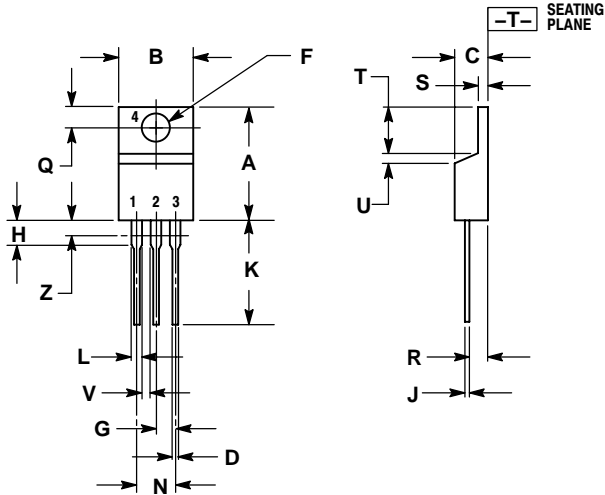


Figure 20. Typical Thermal Response ($Z_{\theta JC}(t)$) for BUL44

BUL44

PACKAGE DIMENSIONS

TO-220AB CASE 221A-09 ISSUE AA



NOTES:


1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.570	0.620	14.48	15.75
B	0.380	0.405	9.66	10.28
C	0.160	0.190	4.07	4.82
D	0.025	0.035	0.64	0.88
F	0.142	0.147	3.61	3.73
G	0.095	0.105	2.42	2.66
H	0.110	0.155	2.80	3.93
J	0.018	0.025	0.46	0.64
K	0.500	0.562	12.70	14.27
L	0.045	0.060	1.15	1.52
N	0.190	0.210	4.83	5.33
Q	0.100	0.120	2.54	3.04
R	0.080	0.110	2.04	2.79
S	0.045	0.055	1.15	1.39
T	0.235	0.255	5.97	6.47
U	0.000	0.050	0.00	1.27
V	0.045	---	1.15	---
Z	---	0.080	---	2.04

STYLE 1:

- PIN 1. BASE
2. COLLECTOR
3. EMITTER
4. COLLECTOR

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